

Specification
For
LTCC 5dB Directional Coupler

Model Name : RCP890A05

Customer :

Title:

Name :

APPROVED

By Date : _____

Signature : _____

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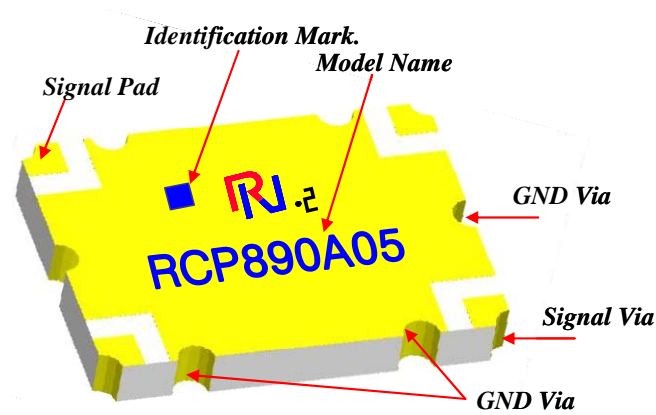
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1. Description

1-1. Part number: RCP890A05



1-2. Features

- Directional Coupler 5dB
- Surface mount type
- Suitable for operation frequency 815 ~ 960MHz
- **RoHS** compliance
- High stability in temperature and humidity for LTCC base
- Low loss for Silver(Ag) conductor
- Miniature size and high power capability
- Lead-free alloy solderable
- Thermal expansion corresponding with common substrate

2. Electrical Specification

Freq. (MHz)	Coupling (dB)	Directivity Max (dB)	Insertion Loss min (dB)
815 - 960	5.0 ± 0.35	-21	-0.19
VSWR Max	Phase (degrees)	Power Capacity Avg. (Watt)	Operating Temp. (°C)
1.2	90 ± 5.0	200	-55 to +125

3. Mechanical Specification

3-1. Outline Dimension

PROJECTION	NO.	DATE	REVISION & DESCRIPTION	SIGNATURE	
				REVIEWED	CHECKED
	1	2008.07.07	New-Drawing		
	2				
	3				

Note.

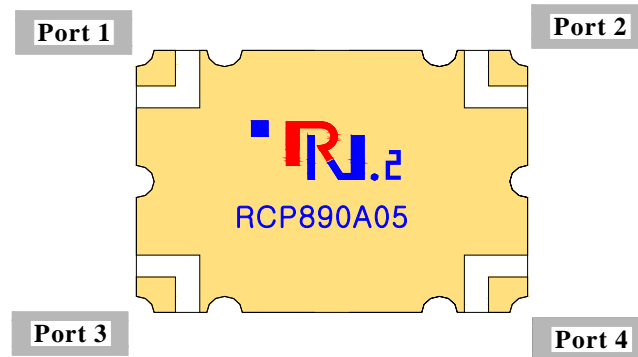
- SMD-type, Ceramic Base.
- Inner signal circuits : Silver(Ag) conductor
- Surface plating : Gold(Au) finished
- Tolerance is not cumulative.

NO.	DESCRIPTION	UNIT	TOTAL	SCALE			
			QUANTITY				
TITLE	A size-Outline	RN2 DWG NO.	08-0707-01	1/1	A4	DIMENSION	mm

3-2. Weight

- 0.7 Grams typical

4. Port Configuration



Configuration	Port 1	Port 2	Port 3	Port 4
Case 1.	Input	Isolated	Coupled	Output
Case 2.	Isolated	Input	Output	Coupled
Case 3.	Coupled	Output	Input	Isolated
Case 4.	Output	Coupled	Isolated	Input

* Once Port 1 is determined, the other three ports are defined automatically.

5. Schematic Drawing

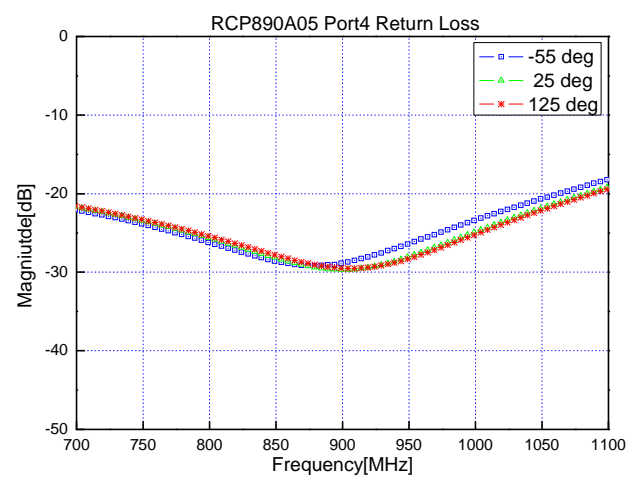
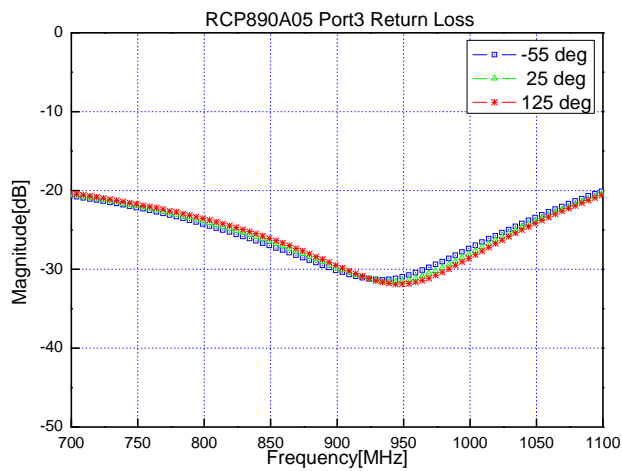
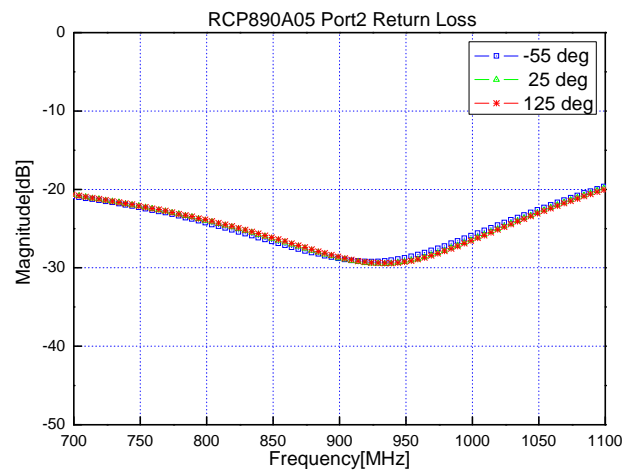
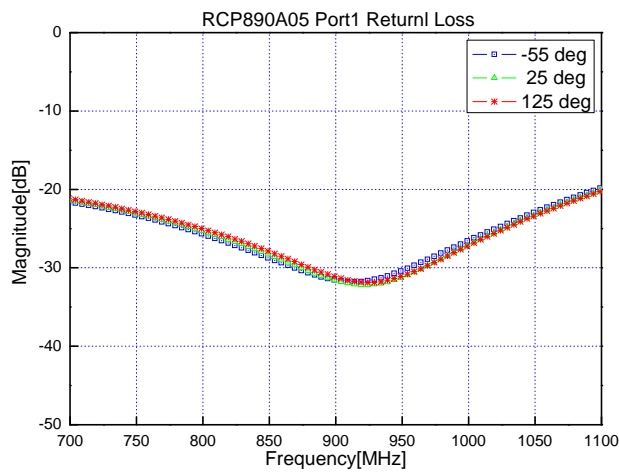


6. Typical Performance Data (25 °C)

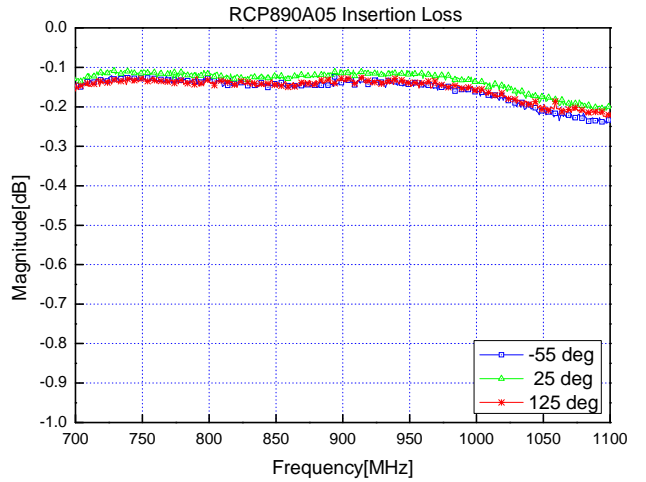
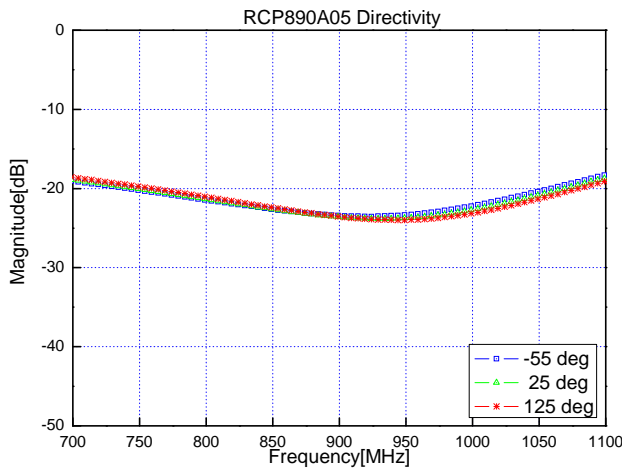
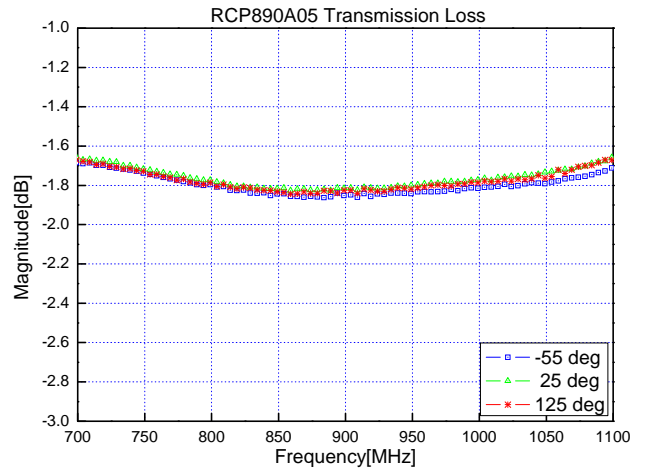
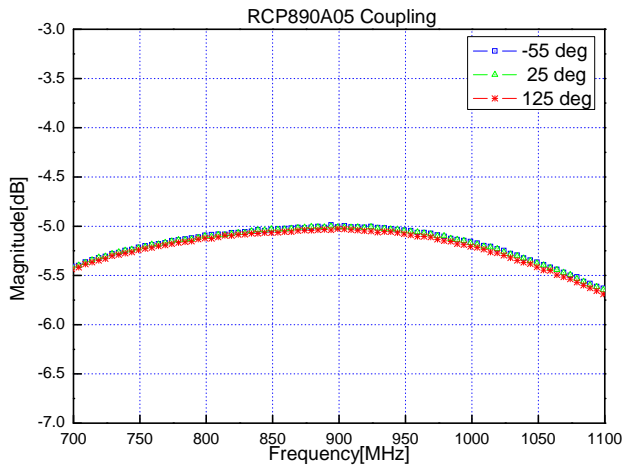
Freq. [MHz]	Coupling [dB]	Out [dB]	IL [dB]	Directivity [dB]	Phase [degree]	Return Loss [dB]			
						S11	S22	S33	S44
815	-5.09	-1.81	-0.14	-21.73	-90.00	-26.16	-24.64	-24.63	-26.39
825	-5.07	-1.81	-0.13	-22.01	-90.04	-26.74	-25.09	-25.12	-26.91
835	-5.06	-1.81	-0.13	-22.26	-89.99	-27.35	-25.58	-25.66	-27.44
845	-5.03	-1.82	-0.12	-22.52	-90.05	-27.99	-26.05	-26.21	-27.94
855	-5.04	-1.82	-0.13	-22.75	-89.97	-28.68	-26.57	-26.81	-28.42
865	-5.02	-1.83	-0.13	-22.98	-89.95	-29.36	-27.09	-27.45	-28.86
875	-5.01	-1.83	-0.12	-23.19	-90.06	-30.10	-27.60	-28.12	-29.25
885	-5.02	-1.82	-0.12	-23.37	-89.93	-30.77	-28.11	-28.80	-29.50
895	-5.01	-1.82	-0.12	-23.53	-89.86	-31.37	-28.57	-29.50	-29.65
905	-5.01	-1.82	-0.12	-23.68	-89.83	-31.84	-28.96	-30.16	-29.66
915	-5.01	-1.82	-0.12	-23.75	-89.81	-32.12	-29.28	-30.77	-29.52
925	-5.01	-1.82	-0.12	-23.81	-89.74	-32.16	-29.45	-31.24	-29.25
935	-5.03	-1.80	-0.11	-23.83	-89.82	-31.93	-29.48	-31.52	-28.84
945	-5.04	-1.81	-0.12	-23.79	-89.76	-31.51	-29.33	-31.54	-28.32
955	-5.06	-1.80	-0.12	-23.68	-89.72	-30.81	-29.05	-31.32	-27.75
960	-5.08	-1.80	-0.13	-23.62	-89.68	-30.50	-28.83	-31.10	-27.43

* Data with PCB and Connector Loss (0.89 GHz = 0.03dB)

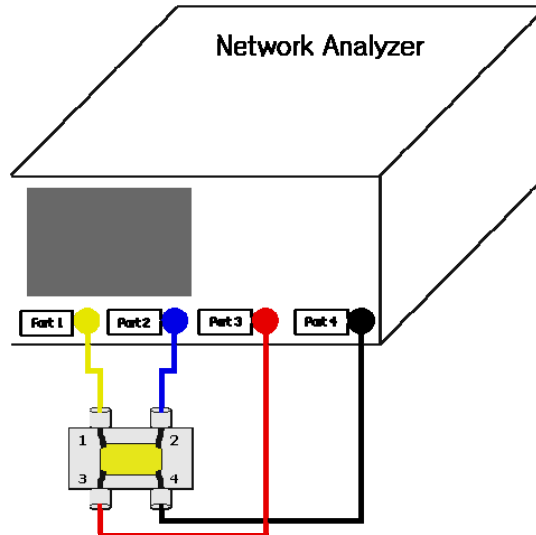
7. Operation Temperature Curve (a)



8. Operation Temperature Curve (b)



9. Test Method



- Refer to 'Case 1' of '4. Port Configuration' on page 4
- Have the network analyzer calibrated properly.
- Measure the data of **Coupling** through port 1 to port 3. (S31)
- Measure the data of **Transmission** through port 1 to port 4. (S41)
- Measure the data of **Isolation** through port 1 to port 2. (S21)
- Calculate the **Insertion Loss** and **Directivity** of coupler on the below power method formula.

	S-Parameter[dB]	Power Method[dB]
Coupling	S31	$10 \cdot \log\left(\frac{P_{cou}}{P_{in}}\right)$
Transmission Loss	S41	$10 \cdot \log\left(\frac{P_{out}}{P_{in}}\right)$
Isolation	S21	$10 \cdot \log\left(\frac{P_{iso}}{P_{in}}\right)$
Insertion Loss		$10 \cdot \log\left(\frac{P_{in}}{P_{cou} + P_{out}}\right)$
Directivity		$10 \cdot \log\left(\frac{P_{cou}}{P_{iso}}\right)$
Phase Balance	$\text{Phase}_{(S31)} - \text{Phase}_{(S41)}$	

P_{in} : Power of Input Port

P_{out} : Power of Output Port

P_{cou} : Power of Coupling Port

P_{iso} : Power of Isolated Port

10. Measurement board layout

PROJECTION	No.	DATE	REVISION & DESCRIPTION	SIGNATURE	
				REVIEWED	CHECKED
	1	2008.06.23	New - Drawing		
	2				
	3				

NOTE. Signal line width is shown for the conditions of;

1. RF-35 (Taconnic) board
2. Dielectric contance 3.5
3. Board thickness 0.8mm
4. Copper thickness 1/2 oz.

No.	DESCRIPTION	UNIT	TOTAL QUANTITY	PERUNIT	TOTAL	SCALE			
						1/1			
TITLE	A size coupler-Measurment Board Outline		RN2 DWG No.	08-0623-01		SCALE	1/1		
						SIZE	A4	DIMENSION	mm

11. Recommended PCB layout and Solder mask pattern

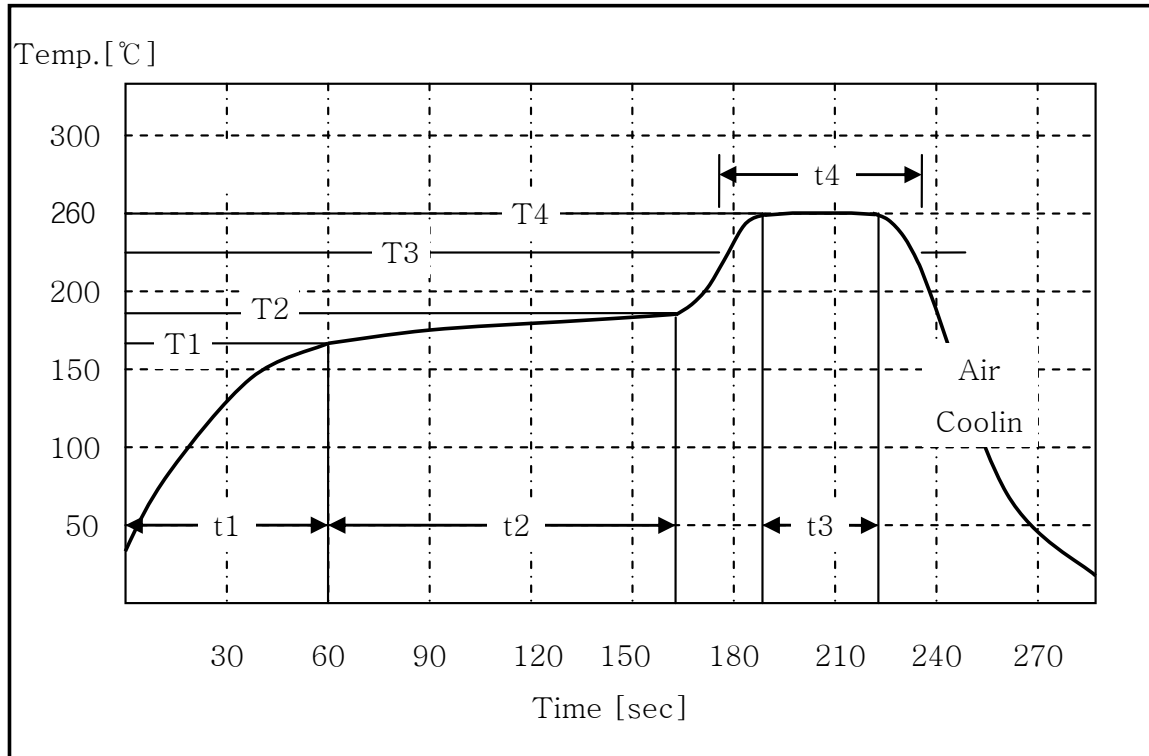
PROJECTION	No.	DATE	REVISION & DESCRIPTION	SIGNATURE	
				REVIEWED	CHECKED
	1	2008.06.23	New - Drawing		
	2				
	3				

NOTE.

1. Test Solder Cream : SAC-305 (Alpa Metal)
2. Lead Free Solder Alloy : Sn/Ag/Cu Ratio Of 96.5/3.0/0.5
3. Solder Area ('A') Demension : 2.0 mm by 1.8 mm
4. Solder Area ('B') Demension : 2.0 mm by 8.0 mm

No.	DESCRIPTION	UNIT	TOTAL	PERUNIT	TOTAL
		QUANTITY			
TITLE	A size - Recommended Solder Quantity &Area	RN2 DWG No.	08-0623-01	SCALE	1/1
				SIZE	A4 DIMENSION mm

12. Reflow profile



	Ramp Up	Pre-Heating	Peak	Soaking
Temp.[°C]	T1:160±5°C	T2:180±5°C	T4:260±5°C	T3:230±5°C
Time [sec]	t1:60±5sec	t2:100±15sec	t3:30±5sec	t4:60±10sec

13. Using note for LTCC Couplers

I. Be careful when transporting

- A. Excessive stress or shock may make products broken or cracked due to the nature of ceramics structure.
- B. The products cracked or damaged on terminals may have their property changed.

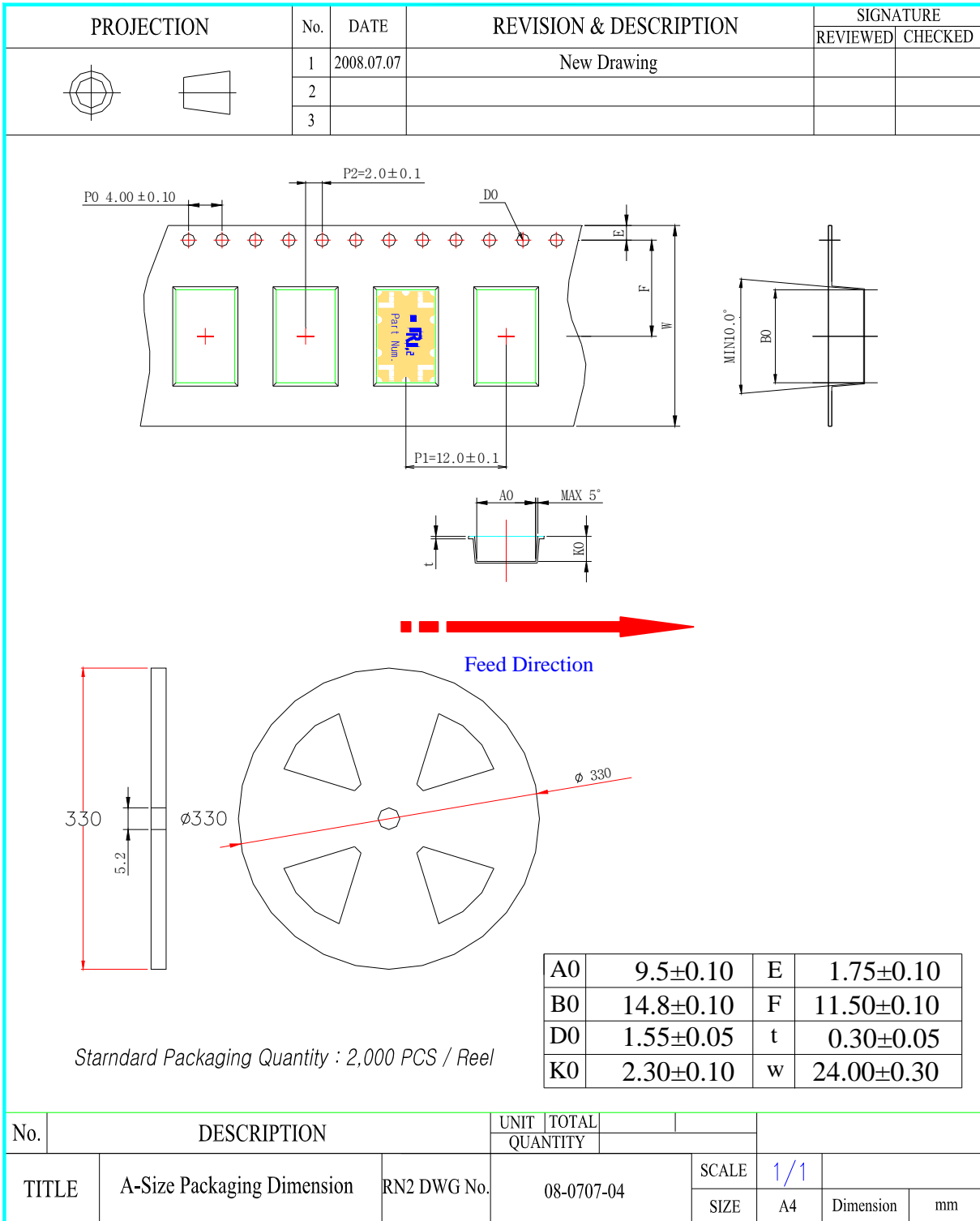
II. Be careful during storage

- A. Store the products in the temperature of $-55 \sim 125^{\circ}\text{C}$
- B. Keep the humidity at $45 \sim 75\%$ around the products.
- C. Prevent corrosive gas (Cl_2 , NH_3 , SO_x , NO_x , etc.) from contacting the products.
- D. It is recommended to use the products within 6 months of receipt. If the period exceeds 6 months, solderability may need to be verified.

III. Be careful when soldering

- A. All the ground terminals, IN and OUT pad of coupler should be soldered on the ground plane of the PCB.
- B. Products may be cracked or broken by uneven forces from a claw or suction device.
- C. Mechanical stress by any other devices may damage products when positioning them on PCB.
- D. A dropped product is recommended not to be used.
- E. Soldering must be carried out by the condition of specification sheet.
- F. Any couplers which are de-soldered from PCB should not be used again.

14. Packaging



15. Environmental Reliability

ITEM	PROCEDURE	REQUIREMENTS/RESULT
Temperature Cycle (Thermal Shock)	1. One Cycle : 30 min Step1: 125 ± 5 °C for 15 min Step2: -55 ± 5 °C for 15 min 2. Approach high or low temperature in 10 seconds 3. Number of Cycles : 100 4. Normal temperature for 1 hour	1. Meet the electrical Specification after test
Solderability	1. Solder : 230 ± 5 °C for 5 ± 1 sec.	1. More than 85% of the I/O electrode pad shall be covered with solder.
Heat Resistance	1. Temperature : 100 ± 2 °C 2. Duration : 96 ± 2 hours	1. Meet the electrical Specification after test
Low Temp. Resistance	1. Temperature : -55 ± 5 °C 2. Duration : 24 ± 2 hours	1. Meet the electrical Specification after test
Vibration Resistance	1. Frequency: 5~ 15MHz 2. Acceleration : 10g 3. Sweep Time: 0.1 oct/min, 15min/axis 4. Axis : X, Y and Z direction	1. No appearance damage 2. Meet the electrical Specification after test
Humidity Resistance	1. One Cycle : Step1: increase Temperature $-25 \sim 65$ °C for 2hours with humidity 85% Step2: Maintain for 4 hour after increasing Humidity 90% to 95% Step3: Decrease Temperature 65 °C to 25 °C 2. Number of Cycles : 10 3. Maintain for 3hour after decreasing temperature -10 °C	1. Meet the electrical Specification after test
Drop Shock	1. Dropped onto hard wood from height of 50 cm for 5 times; each x, y and z direction except I/O direction.	1. No appearance damage 2. Meet the electrical Specification after test

16. RoHS test result

- RN2 Technologies warrants and represents as follows.

Test Report No. F690501/LF-CTSGP06-16067

Date: June 29, 2008

Page 2 of 3

Sample No. : GP06-16067.001
Sample Description : LTCC COUPLER
Style/Item No. : N/A
Comments : Materials are ceramics, Ag.

Heavy Metals

Test items	Unit	Test Method	MDL	Results
Cadmium(Cd)	mg/kg	US EPA 3050B(1996), US EPA 6010B(1996), ICP	0.5	N.D.
Lead (Pb)	mg/kg	US EPA 3050B(1996), US EPA 6010B(1996), ICP	5	N.D.
Mercury (Hg)	mg/kg	US EPA 3052(1996), US EPA 6010B(1996), ICP	2	N.D.
Hexavalent Chromium (Cr VI)	mg/kg	US EPA 3060A(1996), US EPA 7196A(1992), UV	1	N.D.

Flame Retardants-PBBs/PBDEs

Test items	Unit	Test Method	MDL	Results
Monobromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Dibromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Tribromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Tetrabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Pentabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Hexabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Heptabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Octabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Nonabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Decabromobiphenyl	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Monobromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Dibromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Tribromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Tetrabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Pentabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Hexabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Heptabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Octabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Nonabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.
Decabromodiphenyl ether	mg/kg	US EPA 3540C, GC/MS	5	N.D.

NOTE: (1) N.D. = Not detected.(<MDL)
 (2) ppm = mg/kg
 (3) MDL = Method Detection Limit
 (4) - = No regulation
 (5) ** = Qualitative analysis (No Unit)
 (6) Negative = Undetectable / Positive = Detectable

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